# Low-profile type with thickness of 1mm





Ite	ms	Specifications		
Rating (max.)/(min.) (Resistive load)		1mA 5V DC / 50 μA 3V DC		
Contact resistance (Initial / After operating life)		$2\Omega$ max. / $5\Omega$ max.		
Operating force		0.35N max.		
Operating life	Without load	50,000cycles		
Operating life	With load	50,000cycles (1mA 5V DC)		

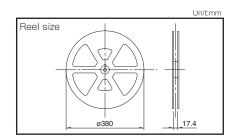
# Product Line

Poles	Positions	Terminal type	Lever length	Operating direction	Location lug	Minimumord Japan	er unit (pcs) Export	Product No.	Drawing No.									
						With	Саран	ZAPOTE	SPVN110107	_								
	l l For PC board (Reflow)	Right		Without			SPVN120104	1										
		Standard	Standard -	Left	With	5,000 20,00	5,000 20,000	SPVN210106	2									
1					Without			SPVN220103										
'			Long	Long	Right	With	5,000   20,000	SPVN310101	3									
					Long	Long	Long	Long	Long	Long	Long	Long	Long			Without		
		LUTIE	1 -64	With	ı		SPVN410101	4										
				Left	Left	Left	Left	Left	Without			SPVN420101	+					

# Packing Specifications

Taping

Nun	nber of packages (p	Tape width	Export package measurements (mm)	
1 reel	1 case /Japan 1 case /export packing			
5,000	10,000	20,000	16	417×409×139



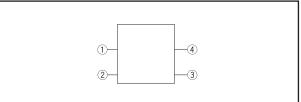
Din	Dimensions							
No.	Photo	Style	PC board mounting hole and land dimensions (Viewed from direction A )					
1	Right operation type with boss	ON starting position (horizontal direction), operating force standard measurement position (horizontal direction).  1.17	1.6 2.00.75 note 1.8 0 0 3.1 4.7					

Dimensions PC board mounting hole and land dimensions (Viewed from direction A ) No. Photo Style Left operation type with boss ON starting position (horizontal direction 2 Total travel position Right operation type with boss 2-00.75 hole 3 Left operation type with boss 4

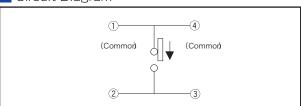
## Note

Dimensions drawing is for type with location lugs.

# Terminal Layout (Viewed from Direction A)



# Circuit Diagram



	Series	General-purpose Type							
551100		SPVS	SPVN	SPVT	SPVM	SPVR	SPVE		
I	Photo			A Sept					
Operation type			1	Two-way			One-way		
	W	3.5	3.8	5.6	2.8	3.6	3.4		
Dimensio (mm)	ins D	3.3	3.6	4.7	3.5	4.2	3		
(11111)	Н		1	1.9	1.5	1.2	2.3		
Operating to	emperature range			−40°C to +85°C	-10℃ to +60℃				
Autor	notive use	•	•	•	•	•	_		
Life cycl	e (availability)	*3	*3	*3	*3	*3	<b>*</b> 3		
Poles	/ Positions			1	/1				
	ng (max.) stive load)	lmA	5V DC	50mA 20V DC	1mA 5V DC		0.1A 30V DC		
Rating (min.) (Resistive load)		50μΑ	3V DC	100μA 3V DC	50μA 3V DC	100μA 3V DC	50μA 3V DC		
	Operating life without load	$50,\!000$ cycles $5\Omega$ max.		100,000cycles 1Ω max.	$50,000$ cycles $5\Omega$ max.		50,000cycles 1Ω max.		
Durability	Operating life with load Rating (max.) (Resistive load)	50,000cycles 5Ω max.		100,000cycles 1Ω max.	50,000cycles $5Ω$ max.		50,000cycles 1Ω max.		
	Initial contact resistance	20	max.	500mΩ max.	2Ω max.	3Ω max.	500mΩ max.		
Electrical performance	Insulation resistance	100MΩ min. 100V DC							
	Voltage proof		100V AC for 1 minute						
Mechanical	Terminal strength		0.5N for 1minute		1N for 1minute	0.5N fo	r 1minute		
performance	Actuator strength	Ę	5N	10N	5N 2N		5N		
	Cold -4		-40℃ 96h	-40°C 96h -20°C 96					
Environmental performance	Dry heat	85°C 96h							
	Damp heat			40°C, 90 to	95%RH 96h				
Opera	ation force	0.35	N max.	0.4N	l max.	0.35N max.	0.3N max.		
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Note

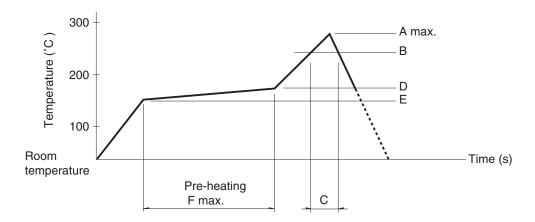
Indicates applicability to all products in the series.

## Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater. 
  2. Temperature measurement: Thermocouple  $\phi$ 0.1 to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface). 
  A heat resisting tape should be used for fixed measurement.

**Detector Switches Soldering Conditions** 

3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (℃)	E (℃)	F(s)
SPPB	250		40			
SPPW8	250		35			120
SPVE		230		180	150	
SPVL						
SPVM						
SPVN	260					
SPVR			40			
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC, SPVQE	250					

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

## Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SPPW8,SSCQ, SSCM, SPVL, SSCT, SPVQC, SPVQE	350±5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s	
SPPB (Reflow)	300±5℃	5s max.	
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s	

# Reference for Dip Soldering (For PC board terminal types)

	Ite	ms	Dip soldering		
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s	
SPPW8, SPPB	100 ℃ max.	60s max.	255±5℃	5±1s	
SSCF	_	_	260±5℃	5±1s	

